



**VSP2212** 

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# CCD SIGNAL PROCESSOR For Digital Cameras

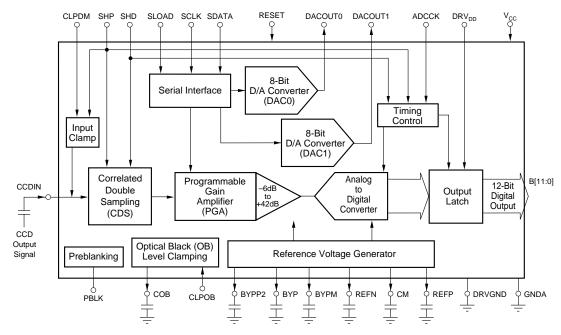
## **FEATURES**

- CCD SIGNAL PROCESSING: Correlated Double Sampling (CDS) Programmable Black Level Clamping
- PROGRAMMABLE GAIN AMPLIFIER (PGA):
   -6 to +42dB Gain Ranging
- 12-BIT DIGITAL DATA OUTPUT: Up to 20MHz Conversion Rate No Missing Codes
- 79dB SIGNAL-TO-NOISE RATIO
- ON-CHIP GENERAL-PURPOSE 8-BIT DIGITAL-TO-ANALOG CONVERTERS
- PORTABLE OPERATION:
   Low Voltage: 2.7V to 3.6V
   Low Power: 99mW (typ) at 3.0V

Stand-By Mode: 6mW

## DESCRIPTION

The VSP2212 is a complete mixed-signal processing IC for digital cameras, providing signal conditioning and analog-to-digital conversion for the output of a CCD array. The primary CCD channel provides Correlated Double Sampling (CDS) to extract video information from the pixels, -6dB to +42dB gain ranging with digital control for varying illumination conditions, and black level clamping for an accurate black reference. Input signal clamping and offset correction of the input CDS is also performed. The stable gain control is linear in dB. Additionally, the black level is quickly recovered after gain change. The two on-chip general-purpose 8-bit digital-to-analog converters allow you to obtain analog various control voltage, such as V<sub>SUB</sub> control of CCD imager. The VSP2212 is the high-performance version of the VSP2000/2100 families. The VSP2212Y is available in an LQFP-48 package and the VSP2212M is avail able in a VQFN-48 package. Both products operate from a single +3V/ +3.3V supply.



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#### PACKAGE OPTION ADDENDUM

16-Jun-2018

#### **PACKAGING INFORMATION**

www.ti.com

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
VSP2212Y	NRND	LQFP	PT	48		Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		VSP2212Y	
VSP2212YG4	NRND	LQFP	PT	48		Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		VSP2212Y	

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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